

1N6845

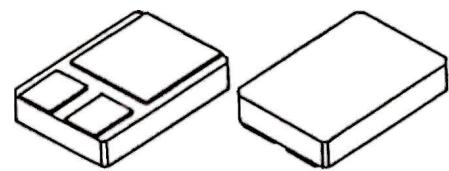
DESIGNER'S DATA SHEET

FEATURES:

- Low Profile Ceramic SMD
- High Surge Rating
- Low Reverse Leakage Current
- Low Forward Voltage
- Seam Welded Package
- Low Capacitance
- Ultrasonic Aluminum Wire Bonds

**45 VOLTS, 40 AMP
 SCHOTTKY RECTIFIER
 CERAMIC SURFACE MOUNT**

SMD-0.5



MAXIMUM RATINGS

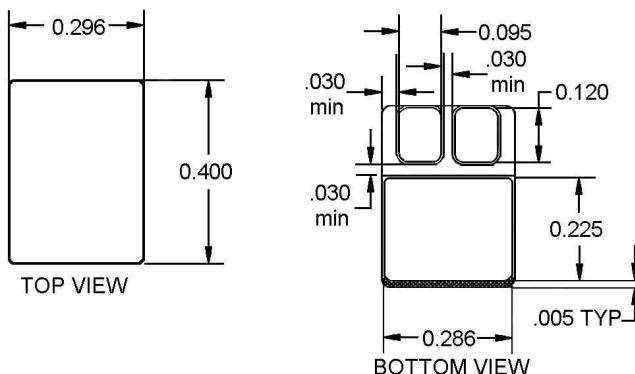
RATING	SYMBOL	VALUE	UNIT
Peak Repetitive Reverse and DC Blocking Voltage 1N6845	V_{RRM} V_{RWN} V_R	45	Volts
Average Rectified Forward Current (Resistive Load, 60Hz, Sine Wave, TA = 25°C)	I_o	40	Amps
Peak Surge Current 8.3 ms Pulse, TA = 25°C	I_{FSM}	400	Amps
Operating & Storage Temperature	Top & Tstg	-55 to +150	°C
Maximum Thermal Resistance Junction to Case,	$R_{\theta JC}$	2.0	°C /W

1/4/00

ELECTRICAL CHARACTERISTICS

CHARACTERISTICS	SYMBOL	MAX.	UNIT
Instantaneous Forward Voltage Drop ($I_F = 10$ Adc, $T_A = 25^\circ\text{C}$, 300us Pulse ($I_F = 20$ Adc, $T_A = 25^\circ\text{C}$, 300 μs Pulse) ($I_F = 40$ Adc, $T_A = 25^\circ\text{C}$, 300 μs Pulse)	V_F	0.65 0.72 0.86	Vdc
Instantaneous Forward Voltage Drop ($I_F = 20$ Adc, $T_A = 100^\circ\text{C}$, 300 μs Pulse) ($I_F = 20$ Adc, $T_A = -55^\circ\text{C}$, 300 μs Pulse)	V_F	0.65 0.78	Vdc
Reverse Leakage Current (Rated VR, $T_A = 25^\circ\text{C}$, 300 μs pulse minimum)	I_R	100	μA
Reverse Leakage Current (Rated VR, $T_A = 100^\circ\text{C}$, 300 μs pulse minimum)	I_R	10	mA
Junction Capacitance $V_R = 10\text{Vdc}$, $T_A = 25^\circ\text{C}$, $f = 1\text{ MHz}$	C_J	800	Pf

CASE OUTLINE: SMD-0.5



TYPICAL OPERATING CURVES

(TA=25°C Unless otherwise specified)

